



Features

- Date rate 622Mbps
- 1310nm FP laser and PIN photodetector for 15km and 40km transmission
- 1310nm DFB laser and PIN photodetector for 40km transmission
- 1550nm uncooled DFB laser and PIN photodetector for 80km transmission
- Digital diagnostic monitor interface compliant with SFF-8472
- SFP MSA package with duplex LC connector
- +3.3V single power supply
- Operating case temperature:
 Standard: -5 to +70°C; Industrial -40~+85°C
- RoHS compliant

Regulatory Compliance

Table 1 - Regulatory Compliance

Electrostatic Discharge	MIL-STD-883E	Class 2(>2000 V)
(ESD) to the Electrical Pins	Method 3015.7	Class 2(>2000 V)
Electrostatic Discharge (ESD) to the	IEC 61000-4-2	Compliant with standards
Duplex LC Receptacle	GR-1089-CORE	Compliant with standards
Clastromagnetic	FCC Part 15 Class B	
Electromagnetic	EN55022 Class B (CISPR 22B)	Compliant with standards
Interference (EMI)	VCCI Class B	
Immunity	IEC 61000-4-3	Compliant with standards
Logar Tyo Cafaty	FDA 21CFR 1040.10 and 1040.11	Compliant with Class I laser
Laser Eye Safety	EN60950, EN (IEC) 60825-1,2	product.
Delle	2002/95/EC 4.1&4.2	Commission with Dolle 6
RoHS	2005/747/EC	Compliant with RoHS 6

Absolute Maximum Ratings

Table 2 - Absolute Maximum Ratings

Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Storage Temperature	Ts	-40	-	+85	°C	



Supply Voltage	V _{cc}	-0.5	-	+3.6	V	
Operating Relative Humidity	RH	+5	-	+95	%	

Recommended Operating Conditions

Table 3 – Recommended Operating Conditions

Para	meter	Symbol	Min.	Typical	Max.	Unit	Notes
Operating Case	Standard	т	-5	-	+70	°C	
Temperature	Industrial	T _C	-40	-	+85		
Power Supply Volta	age	V _{CC}	3.13	3.3	3.47	V	
Power Supply Curr	ent	I _{cc}	-	-	300	mA	
Power Dissipation		P_{D}	-	-	1	W	
Data Rate				622		Mbps	

Optical Characteristics

Table 4 – Optical Characteristics SP-12-IR1-CDFH SP-12-IR1-IDFH (1310nm FP and PIN, 15km, Monitoring function)

	Т	ransmitter				
Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Centre Wavelength	λ _C	1274		1356	nm	
Average Output Power	P _{0UT}	-15		-8	dBm	1
Spectral Width (RMS)	Δλ			2.5	nm	
Extinction Ratio	EX	8.2			dB	
Jitter Generation (RMS)				0.01	UI	
Jitter Generation (pk-pk)				0.1	UI	
Optical Eye Mask	Compliar	nt with Telcord	dia GR-253-CC	RE and ITU-1	Г G.957	2
		Receiver				
Centre Wavelength	λ _C	1260		1580	nm	
Receiver Sensitivity	P _{IN}			-28	dBm	3
Receiver Overload	P _{IN}	-8			dBm	3
Optical Path Penalty				1	dB	4
LOS Assert	LOSA	-42			dBm	
LOS Deassert	LOS _D			-31	dBm	
LOS Hysteresis		1		4	dB	

Notes:

- 1. The optical power is launched into SMF.
- 2. Measured with a PRBS 2²³-1 test pattern @622Mbps.
- 3. Measured with a PRBS 2^{23} -1 test pattern @622Mbps, BER $\leq 1 \times 10^{-10}$.



4. Measured with a PRBS 2^{23} -1 test pattern @622Mbps, over 15km G.652 SMF, BER $\leq 1 \times 10^{-10}$.

Table 5 – Optical Characteristics

SP-12-LR1-CDFH (1310nm FP and PIN, 40km, Monitoring function)

	Т	ransmitter				
Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Centre Wavelength	λ _C	1274		1356	nm	
Average Output Power	P _{0UT}	-3		+2	dBm	1
Spectral Width (RMS)	Δλ			2.5	nm	
Extinction Ratio	EX	10			dB	
Jitter Generation (RMS)				0.01	UI	
Jitter Generation (pk-pk)				0.1	UI	
Optical Eye Mask	Complian	nt with Telcord	dia GR-253-CC	RE and ITU-7	Г G.957	2
		Receiver				
Centre Wavelength	λ _C	1260		1580	nm	
Receiver Sensitivity	P _{IN}			-28	dBm	3
Receiver Overload	P _{IN}	-8			dBm	3
Optical Path Penalty				1	dB	4
LOS Assert	LOS _A	-42			dBm	
LOS Deassert	LOS _D			-31	dBm	
LOS Hysteresis		1		4	dB	

Notes:

- 1. The optical power is launched into SMF.
- 2. Measured with a PRBS 2²³-1 test pattern @622Mbps.
- 3. Measured with a PRBS 2^{23} -1 test pattern @622Mbps, BER $\leq 1 \times 10^{-10}$.
- 4. Measured with a PRBS 2^{23} -1 test pattern @622Mbps, over 40km G.652 SMF, BER $\leq 1 \times 10^{-10}$.

Table 6 - Optical Characteristics

SP-12-LR1-CDFG SP-12-LR1-IDFG (1310nm DFB and PIN, 40km, Monitoring function)

	Т	ransmitter				
Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Centre Wavelength	λ _C	1280		1335	nm	
Average Output Power	P _{0UT}	-3		+2	dBm	1
Spectral Width (-20dB)	Δλ			1	nm	
Side Mode Suppression Ratio	SMSR	30			dB	
Extinction Ratio	EX	10			dB	
Jitter Generation (RMS)				0.01	UI	
Jitter Generation (pk-pk)				0.1	UI	



Optical Eye Mask	Compliant with Telcordia GR-253-CORE and ITU-T G.957					2
		Receiver				
Centre Wavelength	λ _C	1260		1580	nm	
Receiver Sensitivity	P _{IN}			-28	dBm	3
Receiver Overload	P _{IN}	-8			dBm	3
Optical Path Penalty				1	dB	4
LOS Assert	LOSA	-42			dBm	
LOS Deassert	LOS _D			-31	dBm	
LOS Hysteresis		1		4	dB	

Notes:

- 1. The optical power is launched into SMF.
- 2. Measured with a PRBS 2²³-1 test pattern @622Mbps.
- 3. Measured with a PRBS 2^{23} -1 test pattern @622Mbps, BER $\leq 1 \times 10^{-10}$.
- 4. Measured with a PRBS 2^{23} -1 test pattern @622Mbps, over 40km G.652 SMF, BER $\leq 1 \times 10^{-10}$.

Table 7 – Optical Characteristics SP-12-LR2-CDFH SP-12-LR2-IDFH (1550nm DFB and PIN, 80km, Monitoring function)

		• • • •				
	Т	ransmitter				
Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Centre Wavelength	λ _C	1480		1580	nm	
Average Output Power	P _{out}	-3		+2	dBm	1
Spectral Width (-20dB)	Δλ			1	nm	
Side Mode Suppression Ratio	SMSR	30			dB	
Extinction Ratio	EX	10			dB	
Jitter Generation (RMS)				0.01	UI	
Jitter Generation (pk-pk)				0.1	UI	
Optical Eye Mask	Complian	nt with Telcord	lia GR-253-CC	RE and ITU-7	Γ G.957	2
		Receiver				
Centre Wavelength	λ _C	1260		1580	nm	
Receiver Sensitivity	P _{IN}			-28	dBm	3
Receiver Overload	P _{IN}	-8			dBm	3
Optical Path Penalty				1	dB	4
LOS Assert	LOSA	-42			dBm	
LOS Deassert	LOS _D			-31	dBm	
LOS Hysteresis		1		4	dB	

Notes:

- 1. The optical power is launched into SMF.
- 2. Measured with a PRBS 2²³-1 test pattern @622Mbps.
- 3. Measured with a PRBS 2^{23} -1 test pattern @622Mbps, BER $\leq 1 \times 10^{-10}$.
- 4. Measured with a PRBS 2^{23} -1 test pattern @622Mbps, over 80km G.652 SMF, BER $\leq 1 \times 10^{-10}$.



Electrical Characteristics

Table 8 – Electrical Characteristics

	Т	ransmitter				
Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Data Input Swing Differential	V _{IN}	500		2400	mV	1
Input Differential Impedance	Z _{IN}	90	100	110	Ω	
Tx_DIS Disable	V_D	2.0		V _{CC}	V	
Tx_DIS Enable	V _{EN}	GND		GND+0.8	V	
TX_ Fault (Fault)		2.0		Vcc+0.3	V	
TX_ Fault (Normal)		0		0.8	V	
		Receiver				
Data Output Swing Differential	V _{OUT}	370		2000	mV	1
Rx_LOS Fault	V _{LOS-Fault}	2.0		Vcc+0.3	V	
Rx_LOS Normal	V _{LOS-Normal}	GND		GND+0.8	V	

Notes:

1. Internally AC coupled



Recommended Host Board Power Supply Circuit

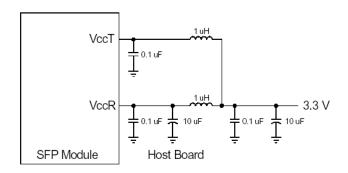


Figure 1, Recommended Host Board Power Supply Circuit

Recommended Interface Circuit

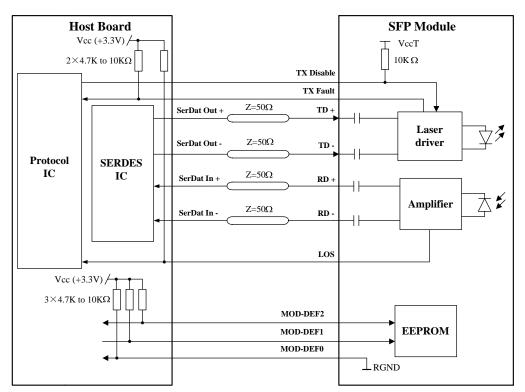


Figure 2, Recommended Interface Circuit



Pin Definitions

Figure 3 below shows the pin numbering of SFP electrical interface. The pin functions are described in Table 9 with some accompanying notes.

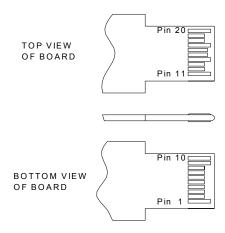


Figure 3, Pin View

Table 9- Pin Function Definitions

Pin No.	Name	Function	Plug Seq.	Notes
1	VeeT	Transmitter Ground	1	
2	TX Fault	Transmitter Fault Indication	3	Note 1
3	TX Disable	Transmitter Disable	3	Note 2
4	MOD-DEF2	Module Definition 2	3	Note 3
5	MOD-DEF1	Module Definition 1	3	Note 3
6	MOD-DEF0	Module Definition 0	3	Note 3
7	Rate Select	Not Connected	3	
8	LOS	Loss of Signal	3	Note 4
9	VeeR	Receiver Ground	1	
10	VeeR	Receiver Ground	1	
11	VeeR	Receiver Ground	1	
12	RD-	Inv. Received Data Out	3	Note 5
13	RD+	Received Data Out	3	Note 5
14	VeeR	Receiver Ground	1	
15	VccR	Receiver Power	2	
16	VccT	Transmitter Power	2	
17	VeeT	Transmitter Ground	1	
18	TD+	Transmit Data In	3	Note 6
19	TD-	Inv. Transmit Data In	3	Note 6
20	VeeT	Transmitter Ground	1	

Notes:

1. TX Fault is an open collector output, which should be pulled up with a 4.7k~10kΩ resistor on the host board to



a voltage between 2.0V and Vcc+0.3V. Logic 0 indicates normal operation; logic 1 indicates a laser fault of some kind. In the low state, the output will be pulled to less than 0.8V.

2. TX Disable is an input that is used to shut down the transmitter optical output. It is pulled up within the module with a $4.7k\sim10k\Omega$ resistor. Its states are:

Low $(0\sim0.8V)$: Transmitter on (>0.8V, <2.0V): Undefined

High (2.0~3.465V): Transmitter Disabled Open: Transmitter Disabled

3. MOD-DEF 0,1,2 are the module definition pins. They should be pulled up with a $4.7k\sim10k\Omega$ resistor on the host board. The pull-up voltage shall be VccT or VccR.

MOD-DEF 0 is grounded by the module to indicate that the module is present

MOD-DEF 1 is the clock line of two wires serial interface for serial ID

MOD-DEF 2 is the data line of two wires serial interface for serial ID

- 4. LOS is an open collector output, which should be pulled up with a 4.7k~10kΩ resistor on the host board to a voltage between 2.0V and Vcc+0.3V. Logic 0 indicates normal operation; logic 1 indicates loss of signal. In the low state, the output will be pulled to less than 0.8V.
- 5. These are the differential receiver output. They are internally AC-coupled 100Ω differential lines which should be terminated with 100Ω (differential) at the user SERDES.
- 6. These are the differential transmitter inputs. They are AC-coupled, differential lines with 100Ω differential termination inside the module.

EEPROM Information

The SFP MSA defines a 256-byte memory map in EEPROM describing the transceiver's capabilities, standard interfaces, manufacturer, and other information, which is accessible over a 2 wire serial interface at the 8-bit address 1010000X (A0h). The memory contents refer to Table 10.

Table 10 - EEPROM Serial ID Memory Contents (A0h)

Addr.	Field Size (Bytes)	Name of Field	Hex	Description
0	1	Identifier	03	SFP
1	1	Ext. Identifier	04	MOD4
2	1	Connector	07	LC
3—10	8	Transceiver	00 xx xx 00 00 00 00 00	OC 12, Single mode inter. or long reach
11	1	Encoding	03	NRZ
12	1	BR, nominal	06	622Mbps
13	1	Reserved	00	
		Length	w	
14	1	(9um)-km	xx	15km/40km/80km(0F/28/50)
15	1	Length (9um)	xx	15km/40km/80km(96/FF/FF)
16	1	Length (50um)	00	
17	1	Length (62.5um)	00	



18	1	Length (copper)	00		
19	1	Reserved	00		
20—35	16	Vendor name	53 4F 55 52 43 45 50 48 4F 54 4F 4E 49 43 53 20	"SOURCEPHOTONICS"(ASC II)	
36	1	Reserved	00		
37—39	3	Vendor OUI	00 00 00		
40—55	16	l Vendor PN	53 50 31 32 xx xx xx xx 44 46 xx 20 20 20 20 20	"SP12xxxxDFx" (ASC II)	
56—59	4	Vendor rev	xx xx 20 20	ASC II ("31 30 20 20" means 1.0 revision)	
60-61	2	Wavelength	05 1E/06 0E	1310nm/1550nm	
62	1	Reserved	00		
63	1	CC BASE	xx	Check sum of bytes 0 - 62	
64—65	2	Options	00 1A	LOS, TX_FAULT and TX_DISABLE	
66	1	BR, max	00		
67	1	BR, min	00		
68—83	16	Vendor SN	xx xx xx xx xx xx xx xx xx xx xx xx xx x	ASC II,	
		Vendor date		Year (2 bytes), Month (2 bytes), Day (2	
84—91	8	code	xx xx xx xx xx xx 20 20	bytes)	
92	1	Diagnostic type	58	Diagnostics(Ext.Cal)	
93	1	Enhanced option	В0	Diagnostics (Optional Alarm/warning flags, Soft TX_FAULT and Soft TX_LOS monitoring)	
94	1	SFF-8472	02	Diagnostics(SFF-8472 Rev 9.4)	
95	1	CC EXT	xx	Check sum of bytes 64 - 94	
96—25 5	160	Vendor specific			

Note: The "xx" byte should be filled in according to practical case. For more information, please refer to the related document of SFF-8472 Rev 9.5.

Monitoring Specification

The digital diagnostic monitoring interface also defines another 256-byte memory map in EEPROM, which makes use of the 8 bit address 1010001X (A2h). Please see Figure 4. For detail EEPROM information, please refer to the related document of SFF-8472 Rev 9.5. The monitoring specification of this product is described in Table 11.



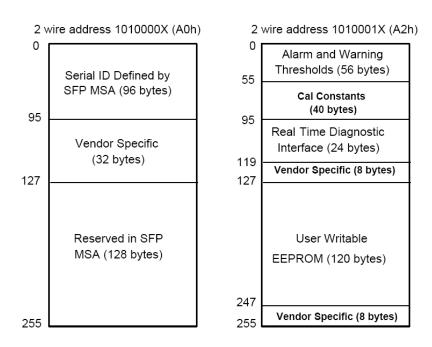


Figure 4, EEPROM Memory Map Specific Data Field Descriptions

Table 11- Monitoring Specification

Parameter			Range	Accuracy	Calibration
Temperature		Standard Temp.	-10 to 80°C	±3°C	External
remperature		Industrial Temp.	-40 to 95°C		
Voltage			3.0 to 3.6V	±3%	External
Bias Current			0 to 100mA	±10%	External
	SP-12-IR1-CDFH		-16 to –7 dBm	±3dB	External
	SP-12-IR1-IDFH				
	SP-12-LR1-CDFH		-4 to +3 dBm		
TX Power	SP-12-LR1-CDFG		-4 to +3 dBm		
	SP-12-LR1-IDFG				
	SP-12-LR2-CDFH		-4 to +3 dBm		
	SP-12-LR2-IDFH				
	SP-12-IR1-CDFH SP-12-IR1-IDFH		-30 to -7 dBm		
	SP-	12-LR1-CDFH	-30 to -7 dBm		
RX Power	SP-12-LR1-CDFG SP-12-LR1-IDFG		-30 to -7 dBm	±3dB	External
	SP-12-LR2-CDFH		-30 to -7 dBm		
	SP-	12-LR2-IDFH	-30 to -1 ubili		



Mechanical Diagram

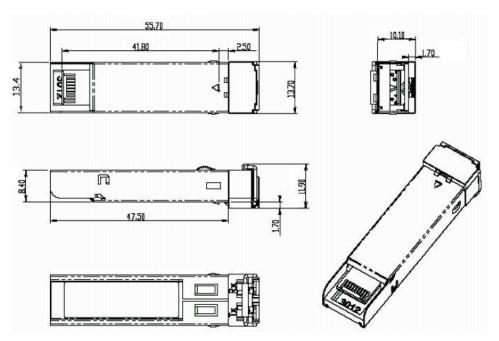


Figure 5, Mechanical Design Diagram of the SFP with Spring-Latch

Order Information

Table 12 - Order Information

Part No.	Application	Data Rate	Laser Source	Fiber Type				
SP-12-IR1-CDFH								
(C-temp)	SDH STM-4, S-4.1	622Mhna	1310nm FP	SMF				
SP-12-IR1-IDFH	SONET OC-12 IR1	622Mbps						
(I-temp)								
SP-12-LR1-CDFH	SDH STM-4, L-4.1	600Mbna	1310nm FP	SMF				
(C-temp)	SONET OC-12 LR1	622Mbps						
SP-12-LR1-CDFG								
(C-temp)	SDH STM-4, L-4.1	600Mhna	1310nm DFB	SMF				
SP-12-LR1-IDFG	SONET OC-12 LR1	622Mbps						
(I-temp)								
SP-12-LR2-CDFH								
(C-temp)	SDH STM-4, L-4.2	622Mbps	1550nm DFB	SMF				
SP-12-LR2-IDFH	SONET OC-12 LR2							
(I-temp)								



Warnings

Handling Precautions: This device is susceptible to damage as a result of electrostatic discharge (ESD). A static free environment is highly recommended. Follow guidelines according to proper ESD procedures.

Laser Safety: Radiation emitted by laser devices can be dangerous to human eyes. Avoid eye exposure to direct or indirect radiation.

Legal Notice

IMPORTANT NOTICE!

All information contained in this document is subject to change without notice, at Source Photonics's sole and absolute discretion. Source Photonics warrants performance of its products to current specifications only in accordance with the company's standard one-year warranty; however, specifications designated as "preliminary" are given to describe components only, and Source Photonics expressly disclaims any and all warranties for said products, including express, implied, and statutory warranties, warranties of merchantability, fi tness for a particular purpose, and non-infringement of proprietary rights. Please refer to the company's Terms and Conditions of Sale for further warranty information.

Source Photonics assumes no liability for applications assistance, customer product design, software performance, or infringement of patents, services, or intellectual property described herein. No license, either express or implied, is granted under any patent right, copyright, or intellectual property right, and Source Photonics makes no representations or warranties that the product(s) described herein are free from patent, copyright, or intellectual property rights. Products described in this document are NOT intended for use in implantation or other life support applications where malfunction may result in injury or death to persons. Source Photonics customers using or selling products for use in such applications do so at their own risk and agree to fully defend and indemnify Source Photonics for any damages resulting from such use or sale.

THE INFORMATION CONTAINED IN THIS DOCUMENT IS PROVIDED ON AN "AS IS" BASIS. Customer agrees that Source Photonics is not liable for any actual, consequential, exemplary, or other damages arising directly or indirectly from any use of the information contained in this document. Customer must contact Source Photonics to obtain the latest version of this publication to verify, before placing any order, that the information contained herein is current.

Contact

U.S.A. Headquarters 20550 Nordhoff Street Chatsworth, CA 91311 USA

Tel: +1-818-773-9044 Fax: +1-818-773-0261 China

Building #2&5, West Export Processing Zone No. 8 Kexin Road, Hi-Tech

Zone

Chengdu, 611731, China Tel: +86-28-8795-8788 Fax: +86-28-8795-8789 **Taiwan**

9F, No 81, Shui Lee Rd. Hsinchu, Taiwan, R.O.C. Tel: +886-3-5169222 Fax: +886-3-5169213



© Copyright Source Photonics, Inc. 2007~2008 All rights reserved